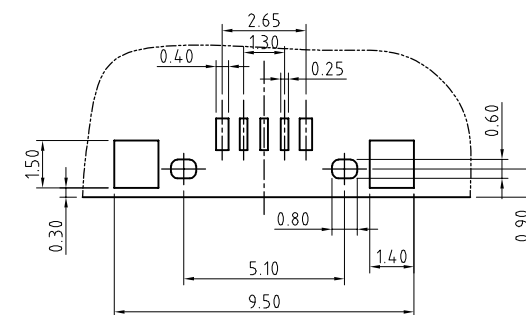
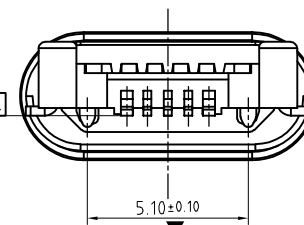
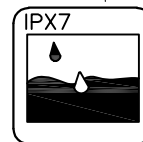
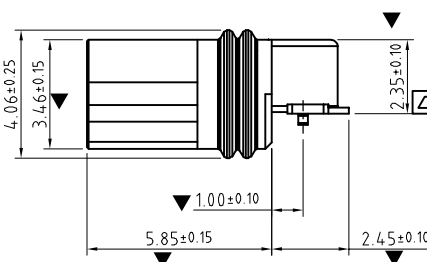
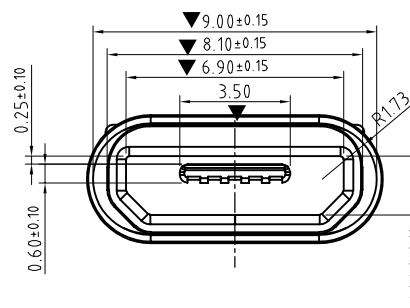
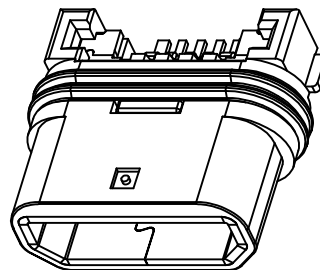
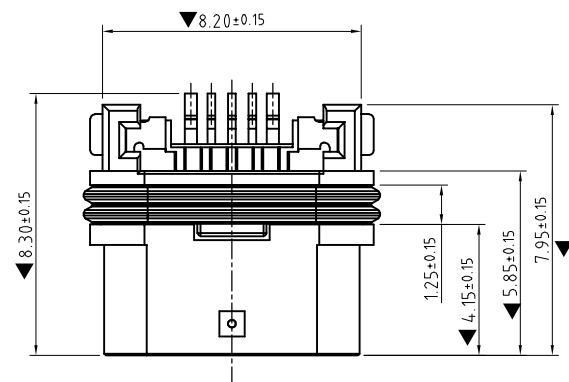


Notes:

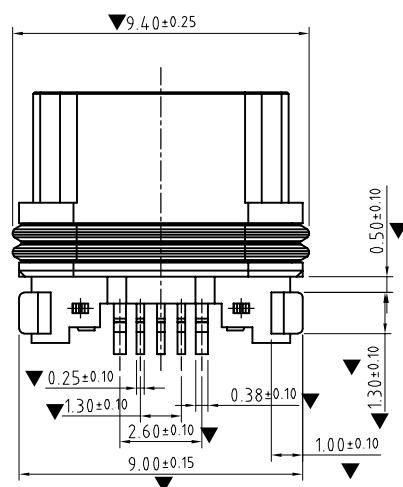
1. Dimension shall be interpreted per ASME Y14.5M1994.
2. Dimension marked ∇ & $\blacktriangledown$ should be checked by Q.C. and process, engineers and ∇ should also check the CPK data.

Specification:

1. Current Rating: 1.0 AMP
2. Voltage Rating: 30V AC,DC
3. Dielectric Strength: 500V AC RMS for 1 minute.
4. Contact Resistance: 30 m Ω Max.
5. Insulator Resistance: 500M Ω Min. AT 250V DC.
6. Mating/Unmating cycles: 2000cycles
7. Temperature: -20°C to +60°C



P.C.B LAYOUT



3	Shell	1	C2680R-H Au/Ni Plating T=0.30mm	
3	Contact	5	Phosphor bronze C5210R-EH Au/Ni Plating T=0.20mm	
2	Housing-2	1	PA9T&LCP (G.F30%)	
1	Housing-1	1	PA9T&LCP (G.F30%)	
ITEM	PART NAME	Q'TY	FINISH	NOTE
X.	±0.50	X.*	±2°	UNITS mm
.X	±0.30	X.*	±1°	
.XX	±0.10	.XX*	±0.5°	MAT'L
.XXX	±0.05			
		FINISH	APPD:	TITLE: Micro USB 5Pin SMT (B) Type (沉板平口防水型 No spring)
		Q'TY	CHKD:	
			DR: Steven.Xie 2021/03/19	
				DWG NO.: 兼容索尼(Z4&Z5)USB
				SCALE SHEET REV. 1/1 1/1 A1

XEB 东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.